## onsemi

## Hex Inverter MM74HCU04

## **General Description**

The MM74HCU04 inverters utilize advanced silicon–gate CMOS technology to achieve operating speeds similar to LS–TTL gates with the low power consumption of standard CMOS integrated circuits.

The MM74HCU04 is an unbuffered inverter. It has high noise immunity and the ability to drive 15 LS–TTL loads. The 74HCU logic family is functionally as well as pin–out compatible with the standard 74LS logic family. All inputs are protected from damage due to static discharge by internal diode clamps to  $V_{CC}$  and ground.

## Features

- Typical Propagation Delay: 7 ns
- Fanout of 15 LS-TTL Loads
- Quiescent Power Consumption: 10 µA Maximum at Room Temperature
- Low Input Current: 1 µA Maximum
- These Devices are Pb-Free, Halide Free and are RoHS Compliant

## **Connection Diagram**

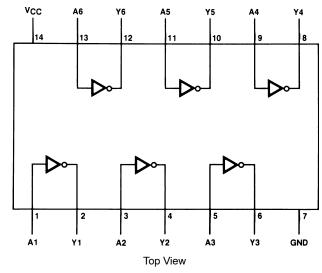
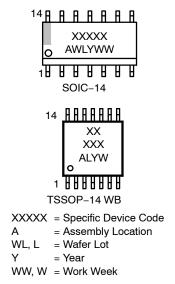


Figure 1. Pin Assignments for SOIC and TSSOP

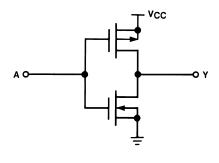


TSSOP-14 WB CASE 948G

## MARKING DIAGRAM



## SCHEMATIC DIAGRAM



## **ORDERING INFORMATION**

See detailed ordering and shipping information on page 4 of this data sheet.

## DATA SHEET www.onsemi.com

## ABSOLUTE MAXIMUM RATINGS (Note 1)

Symbol		Rating	
V <sub>CC</sub>	Supply Voltage	–0.5 to +7.0 V	
V <sub>IN</sub>	DC Input Voltage		–0.5 to V <sub>CC</sub> + 0.5 V
V <sub>OUT</sub>	DC Output Voltage		–0.5 to V <sub>CC</sub> + 0.5 V
I <sub>IK</sub> , I <sub>OK</sub>	Clamp Diode Current	±20 mA	
I <sub>OUT</sub>	DC Output Current, per Pin	±25 mA	
I <sub>CC</sub>	DC $V_{CC}$ or GND Current, per Pin		±50 mA
T <sub>STG</sub>	Storage Temperature Range	–65°C to +150°C	
PD	Power Dissipation S.O. Package Only		500 mW
TL	Lead Temperature (Soldering 10 S	260°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Unless otherwise specified all voltages are referenced to ground.

## **RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter		Max	Unit
V <sub>CC</sub>	Supply Voltage	2	6	V
$V_{\text{IN}}, V_{\text{OUT}}$	DC Input or Output Voltage	0	V <sub>CC</sub>	V
T <sub>A</sub>	Operating Temperature Range	-55	+125	°C

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

## MM74HCU04

### **DC ELECTRICAL CHARACTERISTICS**

		V <sub>cc</sub>		T <sub>A</sub> =	25°C	T <sub>A</sub> = −40°C to 85°C	T <sub>A</sub> = −55°C to 125°C	
Symbol	Parameter	(V)	Conditions	Тур	Guaranteed Limits		Unit	
V <sub>IH</sub>	Minimum HIGH Level Input Voltage	2.0		-	1.7	1.7	1.7	V
		4.5		-	3.6	3.6	3.6	
		6.0		-	4.8	4.8	4.8	
V <sub>IL</sub>	Maximum LOW Level Input Voltage	2.0		-	0.3	0.3	0.3	V
		4.5		-	0.8	0.8	0.8	
		6.0		_	1.1	1.1	1.1	
V <sub>OH</sub>	Minimum HIGH Level Output Voltage	2.0	$V_{IN} = V_{IH} \text{ or } V_{IL},$	2.0	1.8	1.8	1.8	V
		4.5	I <sub>OUT</sub>   ≤ 20 μA	4.5	4.0	4.0	4.0	
		6.0		6.0	5.5	5.5	5.5	
		4.5	$V_{IN} = GND,$ $ I_{OUT}  \le 4.0 \text{ mA}$	4.2	3.98	3.84	3.7	
		6.0	$V_{IN} = GND,$ $ I_{OUT}  \le 5.2 \text{ mA}$	5.7	5.48	5.34	5.2	
V <sub>OL</sub>	Maximum LOW Level Output Voltage	2.0	$V_{IN} = V_{IH} \text{ or } V_{IL},$	0	0.2	0.2	0.2	V
		4.5	I <sub>OUT</sub>   ≤ 20 μΑ	0	0.5	0.5	0.5	
		6.0		0	0.5	0.5	0.5	
		4.5	$\begin{array}{l} V_{IN} = V_{CC}, \\ \left  I_{OUT} \right  \leq 6.0 \text{ mA} \end{array}$	0.2	0.26	0.33	0.4	
		6.0	$\begin{array}{l} V_{IN} = V_{CC}, \\ \left  I_{OUT} \right  \leq 7.8 \text{ mA} \end{array}$	0.2	0.26	0.33	0.4	
I <sub>IN</sub>	Maximum Input Current	6.0	$V_{IN} = V_{CC}$ or GND	-	±0.1	±1.0	±1.0	μA
Icc	Maximum Quiescent Supply Current	6.0	$V_{IN} = V_{CC} \text{ or}$ GND, $I_{OUT} = 0 \ \mu A$	-	2.0	20	40	μΑ

2. For a power supply of 5 V  $\pm$ 10% the worst case output voltages (V<sub>OH</sub>, and V<sub>OL</sub>) occur for HC at 4.5 V. Thus the 4.5 V values should be used when designing with this supply. Worst case V<sub>IH</sub> and V<sub>IL</sub> occur at V<sub>CC</sub> = 5.5 V and 4.5 V respectively. (The V<sub>IH</sub> value at 5.5 V is 3.85 V.) The worst case leakage current (I<sub>IN</sub>, I<sub>CC</sub>, and I<sub>OZ</sub>) occur for CMOS at the higher voltage and so the 6.0 V values should be used.

## AC ELECTRICAL CHARACTERISTICS (V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C, C<sub>L</sub> = 15 pF, $t_r$ = $t_f$ = 6 ns)

Symbol	Parameter	Conditions	Тур	Guaranteed Limit	Unit
t <sub>PHL</sub> , t <sub>PLH</sub>	Maximum Propagation Delay		7	13	ns

## AC ELECTRICAL CHARACTERISTICS (V<sub>CC</sub> = 2.0 V to 6.0 V, $C_L$ = 50 pF, $t_r$ = $t_f$ = 6 ns, unless otherwise specified)

		Vcc		T <sub>A</sub> =	25°C	T <sub>A</sub> = −40°C to 85°C	T <sub>A</sub> = −55°C to 125°C	
Symbol	Parameter	(V)	Conditions	Тур		Guaranteed L	imits	Unit
t <sub>PHL</sub> , t <sub>PLH</sub>	Maximum Propagation Delay	2.0		49	82	103	120	ns
		4.5		9.9	16	21	24	
		6.0		8.4	14	18	20	
t <sub>TLH</sub> , t <sub>THL</sub>	Maximum Output Rise and Fall Time	2.0		30	75	95	110	ns
		4.5		8	15	19	22	
		6.0		7	13	16	19	
C <sub>PD</sub>	Power Dissipation Capacitance (Note 3)		(per gate)	90	-	-	-	pF
C <sub>IN</sub>	Maximum Input Capacitance			8	15	15	15	pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
3. C<sub>PD</sub> determines the no load dynamic power consumption, P<sub>D</sub> = C<sub>PD</sub> V<sub>CC</sub><sup>2</sup> f + I<sub>CC</sub> V<sub>CC</sub>, and the no load dynamic current consumption, I<sub>S</sub> = C<sub>PD</sub> V<sub>CC</sub> f + I<sub>CC</sub>.

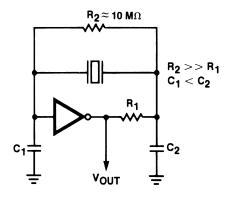
## MM74HCU04

## **ORDERING INFORMATION**

Part Number	Package	Shipping <sup>†</sup>
MM74HCU04M	SOIC-14, Case 751A-03 (Pb-Free, Halide-Free)	55 Units / Tube
MM74HCU04MX	SOIC-14, Case 751A-03 (Pb-Free, Halide-Free)	2500 Units / Tape & Reel
MM74HCU04MTCX	TSSOP-14, Case 948G-01 (Pb-Free, Halide Free)	2500 Units / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

## **Typical Applications**



## Figure 2. Crystal Oscillator

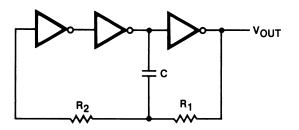


Figure 3. Stable RC Oscillator

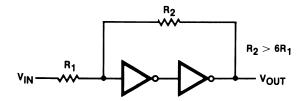


Figure 4. Schmitt Trigger

## DUSEU

0.068

0.019

0.344

0.244



DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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#### SOIC-14 CASE 751A-03 ISSUE L

## DATE 03 FEB 2016

STYLE 1: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. NO CONNECTION 7. ANODE/CATHODE 8. ANODE/CATHODE 9. ANODE/CATHODE 10. NO CONNECTION 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 2: CANCELLED	STYLE 3: PIN 1. NO CONNECTION 2. ANODE 3. ANODE 4. NO CONNECTION 5. ANODE 6. NO CONNECTION 7. ANODE 8. ANODE 9. ANODE 10. NO CONNECTION 11. ANODE 12. ANODE 13. NO CONNECTION 14. COMMON CATHODE	STYLE 4: PIN 1. NO CONNECTION 2. CATHODE 3. CATHODE 4. NO CONNECTION 5. CATHODE 6. NO CONNECTION 7. CATHODE 9. CATHODE 10. NO CONNECTION 11. CATHODE 12. CATHODE 13. NO CONNECTION 14. COMMON ANODE
STYLE 5: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 6. NO CONNECTION 7. COMMON ANODE 8. COMMON CATHODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 6: PIN 1. CATHODE 2. CATHODE 3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE 7. CATHODE 8. ANODE 9. ANODE 10. ANODE 11. ANODE 12. ANODE 13. ANODE 14. ANODE	STYLE 7: PIN 1. ANODE/CATHODE 2. COMMON ANODE 3. COMMON CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 7. ANODE/CATHODE 8. ANODE/CATHODE 10. ANODE/CATHODE 11. COMMON CATHODE 12. COMMON ANODE 13. ANODE/CATHODE 14. ANODE/CATHODE	STYLE 8: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. ANODE/CATHODE 7. COMMON ANODE 8. COMMON ANODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. NO CONNECTION 12. ANODE/CATHODE 13. ANODE/CATHODE 14. COMMON CATHODE

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